\*Customer: Pb Free

# **SPECIFICATION**

ITEM	CHIP LED DEVICE
MODEL	SSC-THBTGFR5210
Revision Date	

# [Contents]

- 1. Features
- 2. Absolute maximum ratings
- 3. Electro-optical characteristics
- 4. Characteristic diagrams
- 5. Soldering profile
- 6. Outline dimension
- 7. Packing
- 8. Reel packing structure
- 9. Precaution for use

# Customer

Approved by	Approved by	Approved by

# **Supplier**

Drawn by	Checked by	Approved by

#### 1. Features

• Full-color lighting SMD Chip LED which makes right-angle mounting available

• Dimension:  $3.0(L)\times1.35(W)\times1.0(H)$ mm

#### 2. Absolute Maximum Ratings

(Ta=25°C)

Parameter	Symbol	Color Value		Unit	Remarks
Power Dissipation	$P_{\mathrm{D}}$	Red	60		
		Green	90	mW	-
		Blue	90		ı
Forward Current	$I_{\mathrm{F}}$	Red	25	mA	
		Green			-
		Blue			
Peak Forward Current	${\rm I_{FM}}^{*1}$	Red	100	mA	-
		Green			
		Blue			
Reverse Voltage	$V_R$		5	V	-
Operating Temperature	$T_{opr}$	-30 ~	- +85	${\mathbb C}$	-
Storage Temperature	$T_{stg}$	-40 ~	+100	°C	-

<sup>\*1</sup>  $I_{FM}$  Conditions: Pulse width Tw $\leq$  1ms, Duty ratio $\leq$  1/20

#### 3. Electro-optical Characteristics

(Ta=25°C)

-						`	
Parameter	Symbol	Condition	Color	Min	Тур	Max	Unit
Forward Voltage	$V_{\mathrm{F}}$	$I_{\mathrm{F}}\!\!=\!\!10$ mA	Red	-	2.1	2.3	V
			Green	-	3.1	3.5	
			Blue	-	3.0	3.4	
Zener Forward Voltage	V	$I_F = 10  \text{mA}$	Blue	0.6	0.8	1.5	V
	$V_{F(Z)}$		Green				
Luminous Intensity*2	$I_{V}$	$I_{\mathrm{F}}\!\!=\!\!10$ mA	Red	35	50	80	mcd
			Green	55	80	150	
			Blue	20	30	60	
Dominant Wavelength	λ <sub>d</sub>	$I_F \!\!=\!\! 10  \text{mA}$	Red	610	625	640	nm
			Green	510	525	540	
			Blue	470	474	480	
Spectral Bandwidth	Δλ	$I_F \!\!=\!\! 10  \text{mA}$	Red	-	20	-	nm
			Green	-	35	-	
			Blue	-	25	-	
Viewing angle*3	20 1/2	$I_F=10\text{mA}$	Red	-	150	-	0
			Green	-	150	-	
			Blue	-	150	-	

<sup>\*2</sup> The luminous intensity  $I_V$  is measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.

[Note] All products confirm to the listed minimum and maximum specifications for electric and optical characteristics, when operated at 10mA within the maximum ratings shown above. All measurements were made under the standardized environment of SSC. (Tolerance:  $V_F \pm 0.1V$ ,  $I_V \pm 10\%$ ,  $\lambda_d \pm 2nm$ )

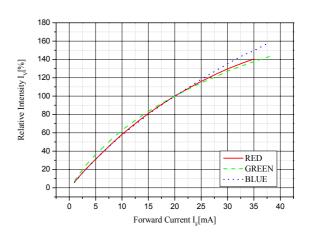
<sup>\*3</sup>  $\Theta_{1/2}$  is the off-axis where the luminous intensity is 1/2 the peak intensity.

## 4. Characteristic Diagrams

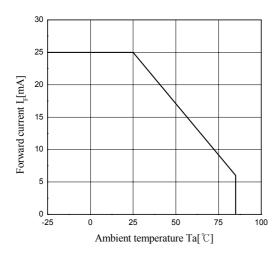
### Forward Current vs. Forward Voltage

# 100 | Temp | 10 |

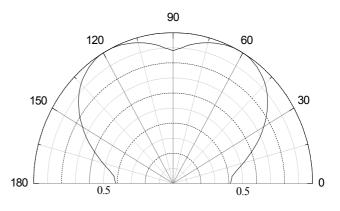
#### Luminous Intensity vs. Forward Current



### Forward Current Derating Curve



# Radiation Diagram

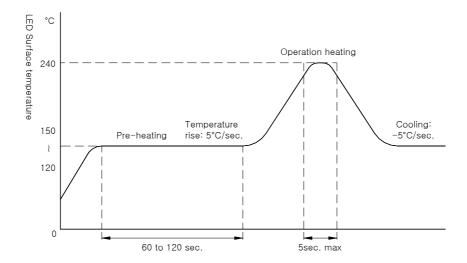


#### 5. Soldering Profile

Reflow Soldering Conditions/ Profile

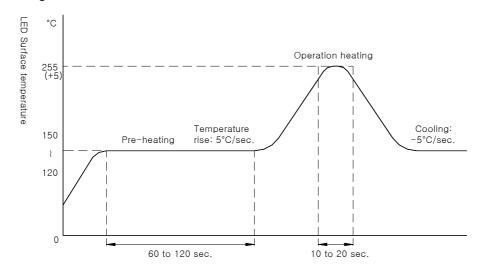
#### (1) Lead Solder

- -Preliminary heating to be at 150 °C max. for 2 minutes max.
- -Soldering heat to be at 240 °C max. for 5 seconds max.



#### (2) Lead-Free Solder

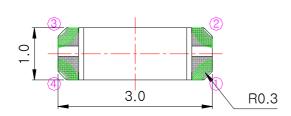
- -Preliminary heating to be at 150 °C max. for 2 minutes max.
- -Soldering heat to be at 255 °C max. for 20 seconds max.

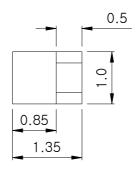


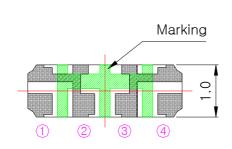
#### (3) Hand Soldering conditions

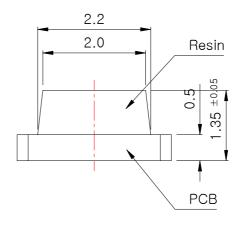
-Not more than 3 seconds @MAX280 ℃, under Soldering iron.

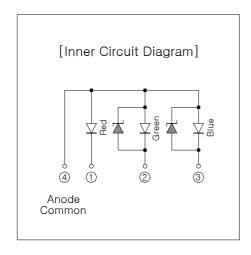
#### 6. Outline Dimension

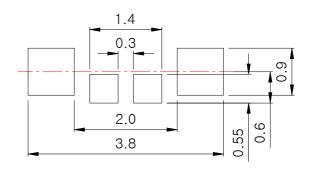








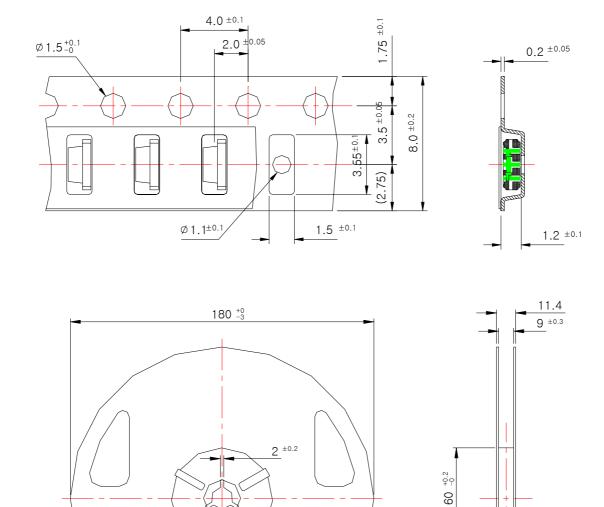




[Recommended Solder Pattern]

Tolerance: ±0.1, Unit: mm

### 7. Packing



Ø 22

Tolerance: ±0.2, Unit: mm

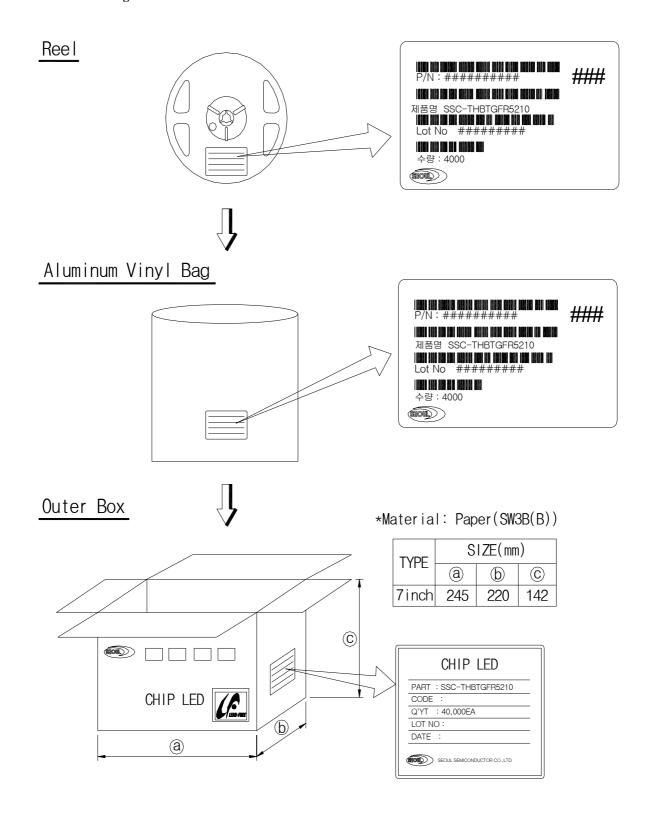
(1) Quantity: 3000pcs/Reel

Label

<u>Ø 1</u>3 <sup>±0.2</sup>

- (2) Cumulative Tolerance : Cumulative Tolerance/10pitches to be  $\,\pm 0.2mm$
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at  $10^{\circ}$  angle to be the carrier tape.
- (4) Package: P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package.

#### 8. Reel Packing Structure



#### 9. Precaution for use

(1) Storage

In order to avoid the absorption of moisture, it is recommended to store in the dry box (or desiccator) with a desiccant. Otherwise, to store them in the following environment is recommended.

Temperature :  $5^{\circ}$ C $\sim$ 30 °C Humidity : 60%HR max.

(2) Attention after opened

However LED is correspond SMD, when LED be soldered dip, interfacial separation may affect the light transmission efficiency, causing the light intensity to drop. Attention in followed.

a. After opened and mounted, the soldering shall be quickly.

b. Keeping of a fraction

Temperature :  $5 \sim 40 \,^{\circ}\text{C}$ 

Humidity: less than 30%

- (3) In case of more than 1 week passed after opening or change color of indicator on desiccant components shall be dried 10-12hr. at  $60\pm5$  °C.
- (4) In case of supposed the components is humid, shall be dried dip-solder just before.

100Hr at  $80\pm5$ °C or 12Hr at  $100\pm5$ °C.

- (5) Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temp. after soldering.
- (6) Quick cooling shall not be avoid.
- (7) Components shall not be mounted on warped direction of PCB.
- (8) Anti radioactive ray design is not considered for the products listed here in.
- (9) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA should be used.
- (10) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (11) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.
- (12) The LEDs must be soldered within seven days after opening the moisture-proof packing.
- (13) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (14) The appearance and specifications of the product may be modified for improvement without notice.
- (15) Static Electricity and surge damages the Blue/Green LEDs.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be properly grounded.

- (16) It is recommended to use individual resistor separately when the LEDs applies in parallel circuit so that it may improve the light deviations.
- (17) It is recommended to examine to the full the circuit by using resistor when the LEDs applies in case of lighting seven colors. (White color is not available with single LED.)